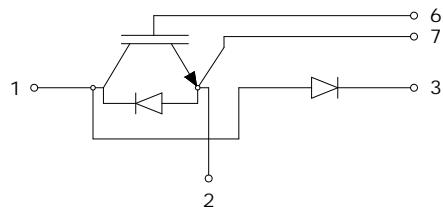


PRELIMINARY DATASHEET

**1200V 150A, Highly Rugged SPT+ IGBT in
iPak® 2 Module Package**

APPLICATION

- Motor drives
- UPS
- High power inverters
- Induction heating



FEATURES

- High speed switching
- Low turn-off losses
- Low conduction loss: $V_{CE(sat)typ} = 1.9V$
- Fast & soft anti-parallel diode
- Pb free finished; **RoHS compliant**



MAXIMUM RATINGS (per Leg)

Parameter	Symbol	Value	Units
Collector-emitter voltage	V_{CES}	1200	V
DC collector current $T_c=80^\circ C$	I_c	150	
Peak collector current	I_{CM}	300	A
Diode forward current $T_c=80^\circ C$	I_F	100	
Peak forward current	I_{FM}	200	
Gate-emitter voltage	V_{GE}	± 20	V
IGBT short circuit withstand time $V_{CC} = 1200V$, $V_{GE} = 15V$, $V_{CEM} \leq 1200V$, $T_{vj} \leq 125^\circ C$	t_{SC}	10	μs
Operating junction and storage temperature	T_j , T_{stg}	-40... +150	$^\circ C$

Thermal and Isolation Characteristics

Parameter	Symbol	Max. Value	Units
Characteristics			
IGBT thermal resistance, junction to case, per Leg	R_{thJC}	0.17	
Diode thermal resistance, junction to case, per Leg	R_{thJCD}	0.31	K/W
Isolation voltage, RMS (measured between terminals and mounting base, 50-60 Hz, for 1-3 seconds)	V_{iso}	3000	V

Electrical Characteristics (per Leg), at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Characteristics						
Collector-emitter breakdown voltage	$V_{(\text{BR})\text{CES}}$	$V_{\text{GE}} = 0\text{V}, I_C = 2\text{mA}$	1200	-	-	V
Collector-emitter saturation voltage	$V_{\text{CE}(\text{sat})}$	$V_{\text{GE}} = 15\text{V}, I_C = 150\text{A}$	-	1.9	2.2	
Diode forward voltage	V_F	$V_{\text{GE}} = 0\text{V}, I_F = 100\text{A}$	-	1.8	2.2	
Gate-emitter threshold voltage	$V_{\text{GE}(\text{th})}$	$I_C = 6\text{ mA}, V_{\text{CE}} = V_{\text{GE}}$	5	-	7	
Zero gate voltage collector current	I_{CES}	$V_{\text{CE}} = 1200\text{V}, V_{\text{GE}} = 0$ $T = 25^\circ\text{C}$	-	-	200	μA
Gate-emitter leakage current	I_{GES}	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = \pm 20\text{V}$	-200	-	200	nA
Internal gate resistance	R_{Gint}		-	1.5	-	Ω

Electrical Characteristics (per Leg), at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Dynamic Characteristics						
Gate charge	Q_g	$I_C = 150\text{A}, V_{\text{CE}} = 600\text{V}, V_{\text{GE}} = \pm 15\text{V}$	-	1560	-	nC
Input capacitance	C_{iss}	$V_{\text{CE}} = 25\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}$	-	11	-	nF
Output capacitance	C_{oss}		-	0.8	-	
Reverse transfer capacitance	C_{rss}		-	0.52	-	
Short circuit current	I_{SC}	$T_j = 125^\circ\text{C}, V_{\text{CC}} = 900\text{V}, V_{\text{GE}} = 15\text{V}, t_{\text{psc}} \leq 10\text{\mu s}, V_{\text{CEM}} \leq 1200\text{V}$	-	700	-	A

Switching Characteristics (per Leg), at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
IGBT Characteristics						
Turn-on delay time	$t_{d(\text{on})}$	$V_{\text{CC}} = 600\text{V}, I_C = 150\text{A}, V_{\text{GE}} = \pm 15\text{V}, R_G = 3.4\Omega, \text{Inductive load.}$	-	240	-	ns
Rise time	t_r		-	46	-	
Turn-off delay time	$t_{d(\text{off})}$		-	328	-	
Fall time	t_f		-	59	-	
Turn-ON energy	E_{on}		-	25	-	mJ
Turn-OFF energy	E_{off}		-	6.6	-	

Anti-Parallel Diode Characteristics (per Leg), at $T_j = 25^\circ\text{C}$, unless otherwise specified

Diode reverse recovery time	t_{rr}	$V_R = 600\text{V}, I_f = 150\text{A}$ $dI/dt = -1000\text{A}/\mu\text{s}$ Inductive load	-	497	-	ns
Diode reverse recovery charge	Q_{rr}		-	15.4	-	μC
Diode peak reverse recovery current	I_{rrm}		-	57	-	A

Figure 1: Typical IGBT turn-on switching times vs R_G , $T_j = 25^\circ C$

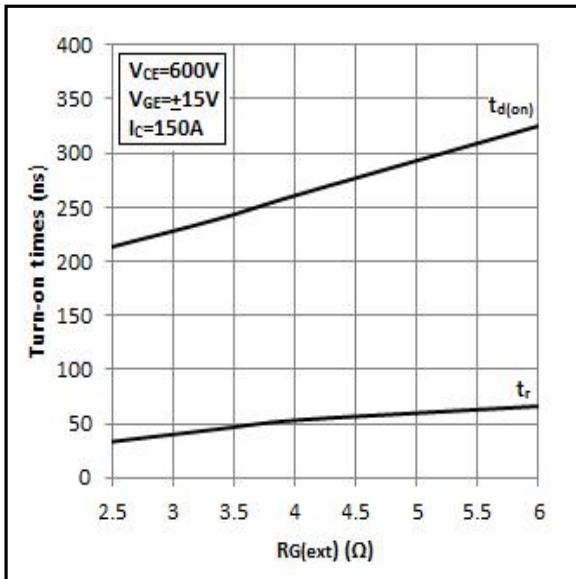


Figure 2: Typical IGBT turn-off switching times vs R_G , $T_j = 25^\circ C$

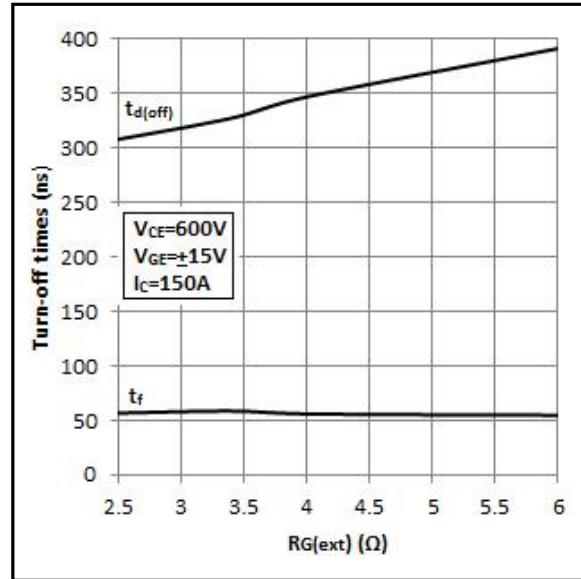


Figure 3: Typical IGBT turn-on switching times vs I_c , $T_j = 25^\circ C$

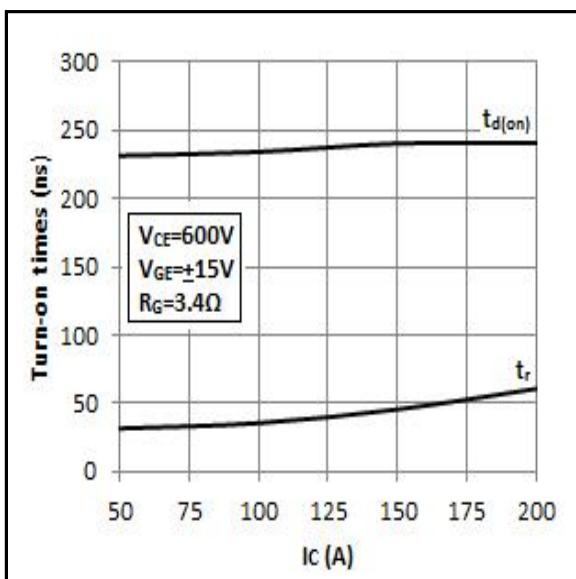


Figure 4: Typical IGBT turn-off switching times vs I_c , $T_j = 25^\circ C$

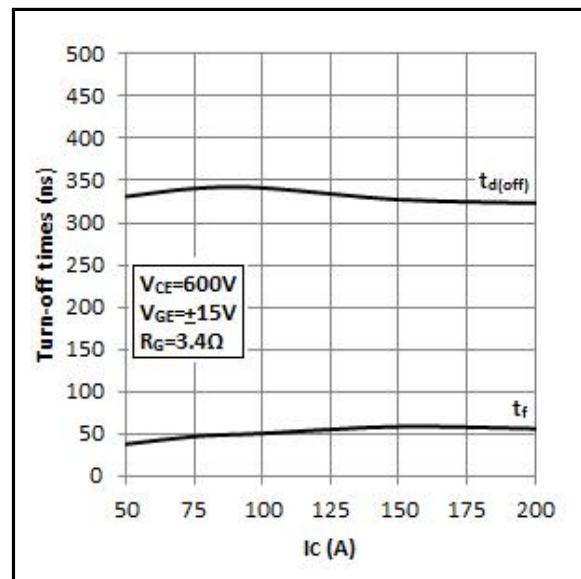


Figure 5: Typical IGBT switching losses vs R_G , $T_J = 25^\circ\text{C}$

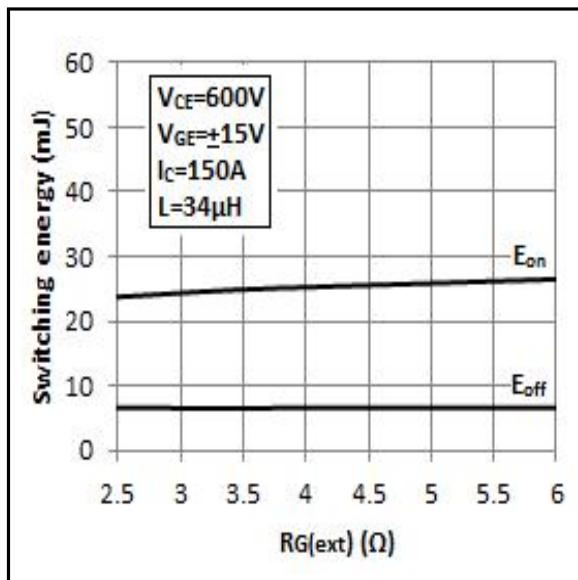
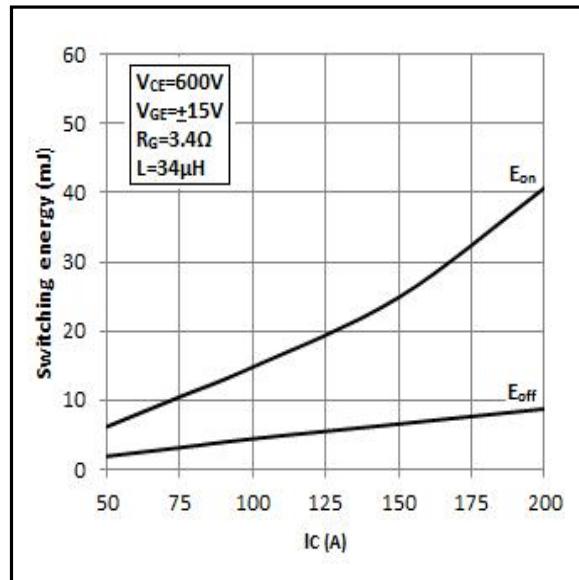
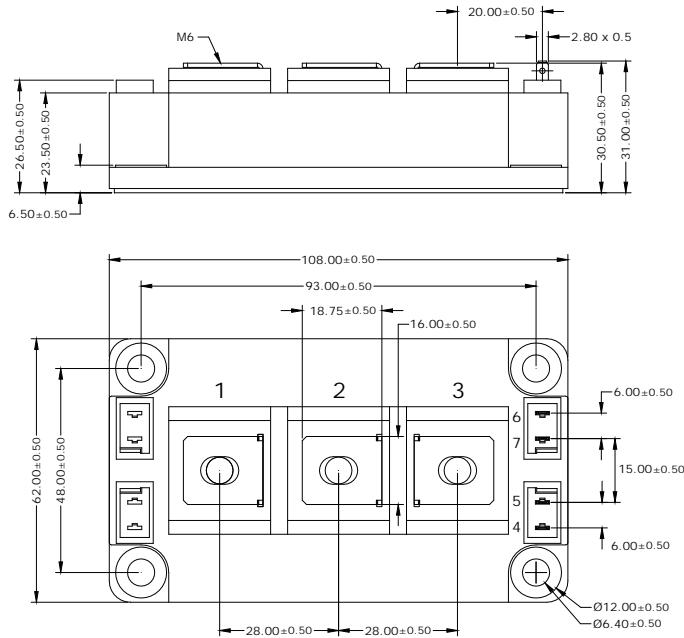


Figure 6: Typical IGBT switching losses vs I_C , $T_J = 25^\circ\text{C}$



Package Outline Drawing



CAUTION: These devices are ESD sensitive. Use proper handling procedure.

Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**